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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	CPU32
Core Size	32-Bit Single-Core
Speed	16MHz
Connectivity	EBI/EMI, SCI, SPI, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	18
Program Memory Size	-
Program Memory Type	ROMless
EEPROM Size	-
RAM Size	-
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	132-BQFP Bumpered
Supplier Device Package	132-PQFP (24.13x24.13)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc68331veh16

1.1 Features

- Modular Architecture
- Central Processing Unit (CPU32)
  - — Upward Object Code Compatible
  - — New Instructions for Controller Applications
  - — 32-Bit Architecture
  - — Virtual Memory Implementation
  - — Loop Mode of Instruction Execution
  - — Table Lookup and Interpolate Instruction
  - — Improved Exception Handling for Controller Applications
  - — Trace on Change of Flow
  - — Hardware Breakpoint Signal, Background Mode
  - — Fully Static Operation
- System Integration Module (SIM)
  - — External Bus Support
  - — Programmable Chip-Select Outputs
  - — System Protection Logic
  - — Watchdog Timer, Clock Monitor, and Bus Monitor
  - — System Protection Logic
  - — System Clock Based on 32.768-kHz Crystal for Low Power Operation
  - — Test/Debug Submodule for Factory/User Test and Development
- Queued Serial Module (QSM)
  - — Enhanced Serial Communication Interface (SCI), Universal Asynchronous Receiver Transmitter (UART): Modulus Baud Rate, Parity
  - — Queued Serial Peripheral Interface (QSPI): 80-Byte RAM, Up to 16 Automatic Transfers
  - — Dual Function I/O Ports
  - — Continuous Cycling, 8 to 16 Bits per Transfer
- General-Purpose Timer (GPT)
  - — Two 16-Bit Free-Running Counters With One Nine-Stage Prescaler
  - — Three Input Capture Channels
  - — Four Output Compare Channels
  - — One Input Capture/Output Compare Channel
  - — One Pulse Accumulator/Event Counter Input
  - — Two Pulse-Width Modulation Outputs
  - — Optional External Clock Input

1.4 Address Map

The following figure is a map of the MCU internal addresses. Unimplemented blocks are mapped externally.

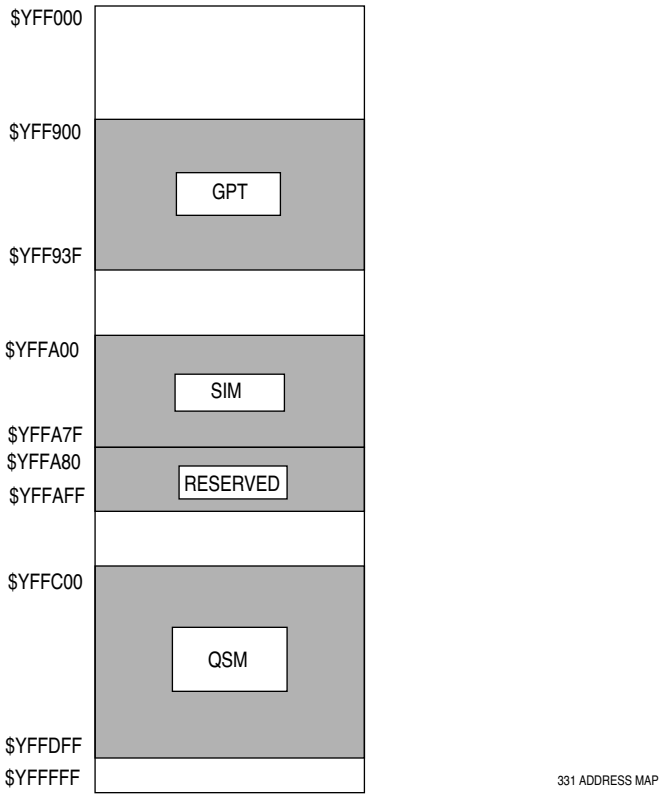


Figure 4 MCU Address Map

1.5 Intermodule Bus

The intermodule bus (IMB) is a standardized bus developed to facilitate both design and operation of modular microcontrollers. It contains circuitry to support exception processing, address space partitioning, multiple interrupt levels, and vectored interrupts. The standardized modules in the MCU communicate with one another and with external components through the IMB. The IMB in the MCU uses 24 address and 16 data lines.

Table 7 SIM Address Map

Access	Address	15 8	7 0
S	$YFFA00	SIM CONFIGURATION (SIMCR)	
S	$YFFA02	FACTORY TEST (SIMTR)	
S	$YFFA04	CLOCK SYNTHESIZER CONTROL (SYNCR)	
S	$YFFA06	NOT USED	RESET STATUS REGISTER (RSR)
S	$YFFA08	MODULE TEST E (SIMTRE)	
S	$YFFA0A	NOT USED	NOT USED
S	$YFFA0C	NOT USED	NOT USED
S	$YFFA0E	NOT USED	NOT USED
S/U	$YFFA10	NOT USED	PORT E DATA (PORTE0)
S/U	$YFFA12	NOT USED	PORT E DATA (PORTE1)
S/U	$YFFA14	NOT USED	PORT E DATA DIRECTION (DDRE)
S	$YFFA16	NOT USED	PORT E PIN ASSIGNMENT (PEPAR)
S/U	$YFFA18	NOT USED	PORT F DATA (PORTF0)
S/U	$YFFA1A	NOT USED	PORT F DATA (PORTF1)
S/U	$YFFA1C	NOT USED	PORT F DATA DIRECTION (DDRF)
S	$YFFA1E	NOT USED	PORT F PIN ASSIGNMENT (PFPAR)
S	$YFFA20	NOT USED	SYSTEM PROTECTION CONTROL (SYPCR)
S	$YFFA22	PERIODIC INTERRUPT CONTROL (PICR)	
S	$YFFA24	PERIODIC INTERRUPT TIMING (PITR)	
S	$YFFA26	NOT USED	SOFTWARE SERVICE (SWSR)
S	$YFFA28	NOT USED	NOT USED
S	$YFFA2A	NOT USED	NOT USED
S	$YFFA2C	NOT USED	NOT USED
S	$YFFA2E	NOT USED	NOT USED
S	$YFFA30	TEST MODULE MASTER SHIFT A (TSTMSRA)	
S	$YFFA32	TEST MODULE MASTER SHIFT B (TSTMSRB)	
S	$YFFA34	TEST MODULE SHIFT COUNT (TSTSC)	
S	$YFFA36	TEST MODULE REPETITION COUNTER (TSTRC)	
S	$YFFA38	TEST MODULE CONTROL (CREG)	
S/U	$YFFA3A	TEST MODULE DISTRIBUTED REGISTER (DREG)	
	$YFFA3C	NOT USED	NOT USED
	$YFFA3E	NOT USED	NOT USED
S/U	$YFFA40	NOT USED	PORT C DATA (PORTC)
	$YFFA42	NOT USED	NOT USED
S	$YFFA44	CHIP-SELECT PIN ASSIGNMENT (CSPAR0)	
S	$YFFA46	CHIP-SELECT PIN ASSIGNMENT (CSPAR1)	
S	$YFFA48	CHIP-SELECT BASE BOOT (CSBARBT)	
S	$YFFA4A	CHIP-SELECT OPTION BOOT (CSORBT)	
S	$YFFA4C	CHIP-SELECT BASE 0 (CSBAR0)	
S	$YFFA4E	CHIP-SELECT OPTION 0 (CSOR0)	
S	$YFFA50	CHIP-SELECT BASE 1 (CSBAR1)	
S	$YFFA52	CHIP-SELECT OPTION 1 (CSOR1)	
S	$YFFA54	CHIP-SELECT BASE 2 (CSBAR2)	
S	$YFFA56	CHIP-SELECT OPTION 2 (CSOR2)	
S	$YFFA58	CHIP-SELECT BASE 3 (CSBAR3)	
S	$YFFA5A	CHIP-SELECT OPTION 3 (CSOR3)	
S	$YFFA5C	CHIP-SELECT BASE 4 (CSBAR4)	

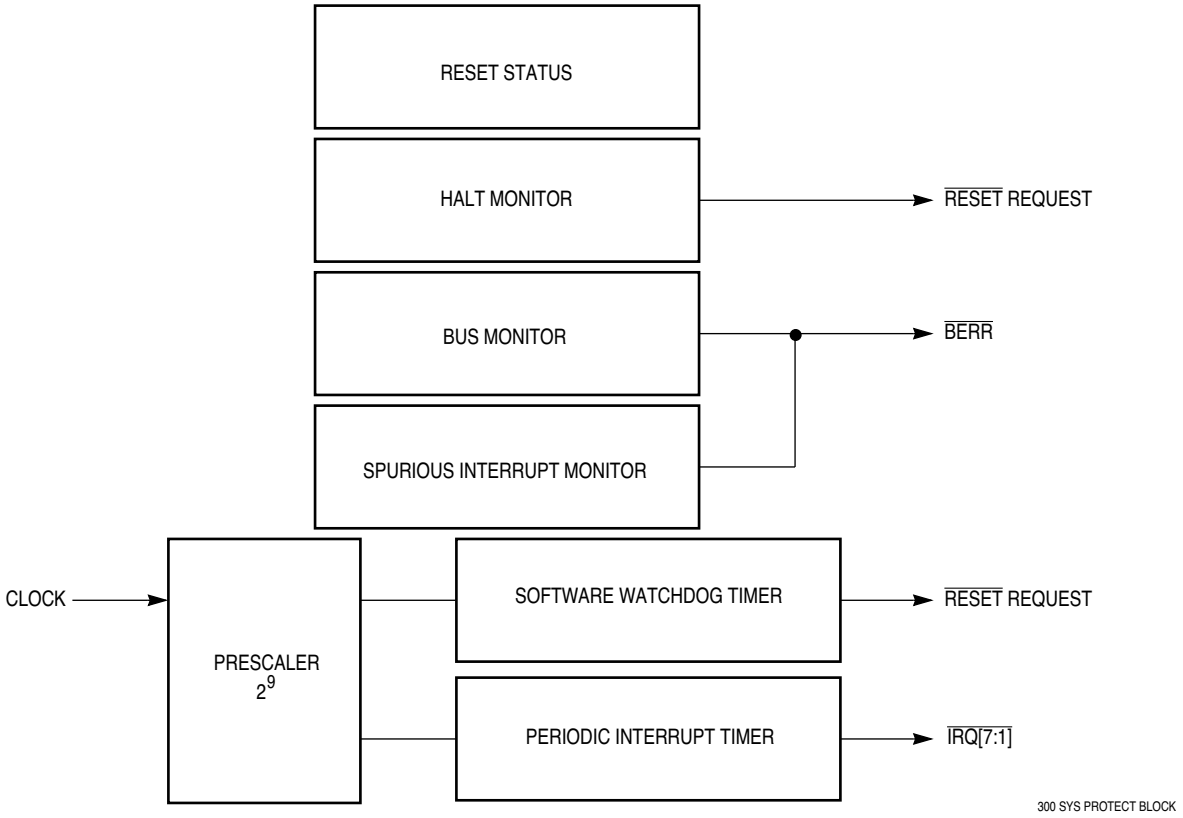


Figure 6 System Configuration and Protection Block

3.2.1 System Configuration

The SIM controls MCU configuration during normal operation and during internal testing.

SIMCR —SIM Configuration Register **$YFFA00**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
EXOFF	FRZSW	FRZBM	0	SLVEN	0	SHEN		SUPV	MM	0	0	IARB			
RESET:															
0	0	0	0	DATA11	0	0	0	1	1	0	0	1	1	1	1

The SIM configuration register controls system configuration. It can be read or written at any time, except for the module mapping (MM) bit, which can be written only once.

EXOFF —External Clock Off

0 = The CLKOUT pin is driven from an internal clock source.
1 = The CLKOUT pin is placed in a high-impedance state.

FRZSW —Freeze Software Enable

0 = When FREEZE is asserted, the software watchdog and periodic interrupt timer counters continue to run.
1 = When FREEZE is asserted, the software watchdog and periodic interrupt timer counters are disabled, preventing interrupts during software debug.

FRZBM —Freeze Bus Monitor Enable

0 = When FREEZE is asserted, the bus monitor continues to operate.
1 = When FREEZE is asserted, the bus monitor is disabled.

SLVEN —Factory Test Mode Enabled

This bit is a read-only status bit that reflects the state of DATA11 during reset.

0 = IMB is not available to an external master.

1 = An external bus master has direct access to the IMB.

SHEN[1:0] —Show Cycle Enable

This field determines what the EBI does with the external bus during internal transfer operations. A show cycle allows internal transfers to be externally monitored. The table below shows whether show cycle data is driven externally, and whether external bus arbitration can occur. To prevent bus conflict, external peripherals must not be enabled during show cycles.

SHEN	Action
00	Show cycles disabled, external arbitration enabled
01	Show cycles enabled, external arbitration disabled
10	Show cycles enabled, external arbitration enabled
11	Show cycles enabled, external arbitration enabled, internal activity is halted by a bus grant

SUPV —Supervisor/Unrestricted Data Space

The SUPV bit places the SIM global registers in either supervisor or user data space.

0 = Registers with access controlled by the SUPV bit are accessible from either the user or supervisor privilege level.

1 = Registers with access controlled by the SUPV bit are restricted to supervisor access only.

MM —Module Mapping

0 = Internal modules are addressed from $7FF000 –$7FFFFF.

1 = Internal modules are addressed from $FFF000 –$FFFFFF.

IARB[3:0] —Interrupt Arbitration Field

Each module that can generate interrupt requests has an interrupt arbitration (IARB) field. Arbitration between interrupt requests of the same priority is performed by serial contention between IARB field bit values. Contention must take place whenever an interrupt request is acknowledged, even when there is only a single pending request. An IARB field must have a non-zero value for contention to take place. If an interrupt request from a module with an IARB field value of %0000 is recognized, the CPU processes a spurious interrupt exception. Because the SIM routes external interrupt requests to the CPU, the SIM IARB field value is used for arbitration between internal and external interrupts of the same priority. The reset value of IARB for the SIM is %1111, and the reset IARB value for all other modules is %0000, which prevents SIM interrupts from being discarded during initialization.

3.2.2 System Protection Control Register

The system protection control register controls system monitor functions, software watchdog clock prescaling, and bus monitor timing. This register can be written only once following power-on or reset, but can be read at any time.

SYPCR —System Protection Control Register **$YFFA21**

15 … 8	7	6	5	4	3	2	1	0
NOT USED	SWE	SWP	SWT		HME	BME	BMT	
RESET:	1	$\overline{\text{MODCLK}}$	0	0	0	0	0	0

SWE —Software Watchdog Enable

0 = Software watchdog disabled

1 = Software watchdog enabled

Block Size Field	Block Size	Address Lines Compared
000	2 K	ADDR[23:11]
001	8 K	ADDR[23:13]
010	16 K	ADDR[23:14]
011	64 K	ADDR[23:16]
100	128 K	ADDR[23:17]
101	256 K	ADDR[23:18]
110	512 K	ADDR[23:19]
111	1 M	ADDR[23:20]

ADDR[23:11] —Base Address Field

This field sets the starting address of a particular address space. The address compare logic uses only the most significant bits to match an address within a block. The value of the base address must be a multiple of block size. Base address register diagrams show how base register bits correspond to address lines.

3.5.4 Option Registers

The option registers contain eight fields that determine timing of and conditions for assertion of chip-select signals. For a chip-select signal to be asserted, all bits in the base address register must match the corresponding internal upper address lines, and all conditions specified in the option register must be satisfied. These conditions also apply to providing $\overline{\text{DSACK}}$ or autovector support.

CSORBT —Chip-Select Option Register Boot ROM **$YFFA4A**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MODE	BYTE		R/$\overline{\text{W}}$		STRB	DSACK				SPACE		IPL			$\overline{\text{AVEC}}$
RESET:															
0	1	1	1	1	0	1	1	0	1	1	1	0	0	0	0

CSOR[10:0] —Chip-Select Option Registers **$YFFA4E–$YFFA76**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MODE	BYTE		R/$\overline{\text{W}}$		STRB	DSACK				SPACE		IPL			$\overline{\text{AVEC}}$
RESET:															
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

CSORBT, the option register for $\overline{\text{CSBOOT}}$, contains special reset values that support bootstrap operations from peripheral memory devices.

The following bit descriptions apply to both CSORBT and CSOR[10:0] option registers.

MODE —Asynchronous/Synchronous Mode

0 = Asynchronous mode selected (chip-select assertion determined by internal or external bus control signals)

1 = Synchronous mode selected (chip-select assertion synchronized with ECLK signal)

In asynchronous mode, the chip select is asserted synchronized with $\overline{\text{AS}}$ or $\overline{\text{DS}}$.

The $\overline{\text{DSACK}}$ field is not used in synchronous mode because a bus cycle is only performed as a synchronous operation. When a match condition occurs on a chip select programmed for synchronous operation, the chip select signals the EBI that an ECLK cycle is pending.

BYTE —Upper/Lower Byte Option

This field is used only when the chip-select 16-bit port option is selected in the pin assignment register. The following table lists upper/lower byte options.

Byte	Description
00	Disable
01	Lower Byte
10	Upper Byte
11	Both Bytes

R/$\overline{W}$ —Read/Write

This field causes a chip select to be asserted only for a read, only for a write, or for both read and write. Refer to the following table for options available.

R/$\overline{W}$	Description
00	Reserved
01	Read Only
10	Write Only
11	Read/Write

STRB —Address Strobe/Data Strobe

0 = Address strobe

1 = Data strobe

This bit controls the timing for assertion of a chip select in asynchronous mode. Selecting address strobe causes chip select to be asserted synchronized with address strobe. Selecting data strobe causes chip select to be asserted synchronized with data strobe.

$\overline{DSACK}$ —Data and Size Acknowledge

This field specifies the source of $\overline{DSACK}$ in asynchronous mode. It also allows the user to adjust bus timing with internal $\overline{DSACK}$ generation by controlling the number of wait states that are inserted to optimize bus speed in a particular application. The following table shows the $\overline{DSACK}$ field encoding. The fast termination encoding (1110) is used for two-cycle access to external memory.

$\overline{DSACK}$	Description
0000	No Wait States
0001	1 Wait State
0010	2 Wait States
0011	3 Wait States
0100	4 Wait States
0101	5 Wait States
0110	6 Wait States
0111	7 Wait States
1000	8 Wait States
1001	9 Wait States
1010	10 Wait States
1011	11 Wait States
1100	12 Wait States
1101	13 Wait States
1110	Fast Termination
1111	External $\overline{DSACK}$

SPACE —Address Space

Use this option field to select an address space for the chip-select logic. The CPU32 normally operates in supervisor or user space, but interrupt acknowledge cycles must take place in CPU space.

Space Field	Address Space
00	CPU Space
01	User Space
10	Supervisor Space
11	Supervisor/User Space

IPL —Interrupt Priority Level

If the space field is set for CPU space (00), chip-select logic can be used for interrupt acknowledge. During an interrupt acknowledge cycle, the priority level on address lines ADDR[3:1] is compared to the value in the IPL field. If the values are the same, a chip select is asserted, provided that other option register conditions are met. The following table shows IPL field encoding.

IPL	Description
000	Any Level
001	IPL1
010	IPL2
011	IPL3
100	IPL4
101	IPL5
110	IPL6
111	IPL7

This field only affects the response of chip selects and does not affect interrupt recognition by the CPU. Any level means that chip select is asserted regardless of the level of the interrupt acknowledge cycle.

$\overline{\text{AVEC}}$ —Autovector Enable

0 = External interrupt vector enabled

1 = Autovector enabled

This field selects one of two methods of acquiring the interrupt vector during the interrupt acknowledge cycle. It is not usually used in conjunction with a chip-select pin.

If the chip select is configured to trigger on an interrupt acknowledge cycle (SPACE = 00) and the $\overline{\text{AVEC}}$ field is set to one, the chip select automatically generates an $\overline{\text{AVEC}}$ in response to the interrupt cycle. Otherwise, the vector must be supplied by the requesting device.

The $\overline{\text{AVEC}}$ bit must not be used in synchronous mode, as autovector response timing can vary because of ECLK synchronization.

3.5.5 Port C Data Register

Bit values in port C determine the state of chip-select pins used for discrete output. When a pin is assigned as a discrete output, the value in this register appears at the output. This is a read/write register. Bit 7 is not used. Writing to this bit has no effect, and it always returns zero when read.

PORTC — Port C Data Register **$YFFA41**

15 … 8	7	6	5	4	3	2	1	0
NOT USED	0	PC6	PC5	PC4	PC3	PC2	PC1	PC0
RESET:	0	1	1	1	1	1	1	1

3.6 General-Purpose Input/Output

SIM pins can be configured as two general-purpose I/O ports, E and F. The following paragraphs describe registers that control the ports.

PORTE0, PORTE1 —Port E Data Register **$YFFA11, $YFFA13**

15 … 8	7	6	5	4	3	2	1	0
NOT USED	PE7	PE6	PE5	PE4	PE3	PE2	PE1	PE0
RESET:	U	U	U	U	U	U	U	U

A write to the port E data register is stored in the internal data latch and, if any port E pin is configured as an output, the value stored for that bit is driven on the pin. A read of the port E data register returns the value at the pin only if the pin is configured as a discrete input. Otherwise, the value read is the value stored in the register.

The port E data register is a single register that can be accessed in two locations. When accessed at $YFFA11, the register is referred to as PORTE0; when accessed at $YFFA13, the register is referred to as PORTE1. The register can be read or written at any time. It is unaffected by reset.

DDRE — Port E Data Direction Register **$YFFA15**

15 … 8	7	6	5	4	3	2	1	0
NOT USED	DDE7	DDE6	DDE5	DDE4	DDE3	DDE2	DDE1	DDE0
RESET:	0	0	0	0	0	0	0	0

The bits in this register control the direction of the pin drivers when the pins are configured as I/O. Any bit in this register set to one configures the corresponding pin as an output. Any bit in this register cleared to zero configures the corresponding pin as an input. This register can be read or written at any time.

PEPAR — Port E Pin Assignment Register **$YFFA17**

15 … 8	7	6	5	4	3	2	1	0
NOT USED	PEPA7	PEPA6	PEPA5	PEPA4	PEPA3	PEPA2	PEPA1	PEPA0
RESET:	DATA8	DATA8	DATA8	DATA8	DATA8	DATA8	DATA8	DATA8

The bits in this register control the function of each port E pin. Any bit set to one configures the corresponding pin as a bus control signal, with the function shown in the following table. Any bit cleared to zero defines the corresponding pin to be an I/O pin, controlled by PORTE and DDRE.

Data bus bit 8 controls the state of this register following reset. If DATA8 is set to one during reset, the register is set to $FF, which defines all port E pins as bus control signals. If DATA8 is cleared to zero during reset, this register is set to $00, configuring all port E pins as I/O pins.

Any bit cleared to zero defines the corresponding pin to be an I/O pin. Any bit set to one defines the corresponding pin to be a bus control signal.

Table 16 Port E Pin Assignments

PEPAR Bit	Port E Signal	Bus Control Signal
PEPA7	PE7	SIZ1
PEPA6	PE6	SIZ0
PEPA5	PE5	$\overline{AS}$
PEPA4	PE4	$\overline{DS}$
PEPA3	PE3	$\overline{RMC}$
PEPA2	PE2	$\overline{AVEC}$
PEPA1	PE1	$\overline{DSACK1}$
PEPA0	PE0	$\overline{DSACK0}$

Table 19 Module Pin Functions

Module	Pin Mnemonic	Function
CPU32	DSI/IFETCH	DSI/IFETCH
	DSO/IPIPE	DSO/IPIPE
	BKPT/DSCLK	BKPT/DSCLK
GPT	PGP7/IC4/OC5	Discrete Input
	PGP[6:3]/OC[4:1]	Discrete Input
	PGP[2:0]/IC[3:1]	Discrete Input
	PAI	Discrete Input
	PCLK	Discrete Input
	PWMA, PWMB	Discrete Output
QSM	PQS7/TXD	Discrete Input
	PQS[6:4]/PCS[3:1]	Discrete Input
	PQS3/PCS0/SS	Discrete Input
	PQS2/SCK	Discrete Input
	PQS1/MOSI	Discrete Input
	PQS0/MISO	Discrete Input
	RXD	RXD

3.7.3 Reset Timing

The RESET input must be asserted for a specified minimum period in order for reset to occur. External RESET assertion can be delayed internally for a period equal to the longest bus cycle time (or the bus monitor time-out period) in order to protect write cycles from being aborted by reset. While RESET is asserted, SIM pins are either in a disabled high-impedance state or are driven to their inactive states.

When an external device asserts RESET for the proper period, reset control logic clocks the signal into an internal latch. The control logic drives the RESET pin low for an additional 512 CLKOUT cycles after it detects that the RESET signal is no longer being externally driven, to guarantee this length of reset to the entire system.

If an internal source asserts a reset signal, the reset control logic asserts RESET for a minimum of 512 cycles. If the reset signal is still asserted at the end of 512 cycles, the control logic continues to assert RESET until the internal reset signal is negated.

After 512 cycles have elapsed, the reset input pin goes to an inactive, high-impedance state for 10 cycles. At the end of this 10-cycle period, the reset input is tested. When the input is at logic level one, reset exception processing begins. If, however, the reset input is at logic level zero, the reset control logic drives the pin low for another 512 cycles. At the end of this period, the pin again goes to high-impedance state for 10 cycles, then it is tested again. The process repeats until RESET is released.

3.7.4 Power-On Reset

When the SIM clock synthesizer is used to generate the system clock, power-on reset involves special circumstances related to application of system and clock synthesizer power. Regardless of clock source, voltage must be applied to clock synthesizer power input pin V_{DDSYN} in order for the MCU to operate. The following discussion assumes that V_{DDSYN} is applied before and during reset. This minimizes crystal start-up time. When V_{DDSYN} is applied at power-on, start-up time is affected by specific crystal parameters and by oscillator circuit design. V_{DD} ramp-up time also affects pin state during reset.

During power-on reset, an internal circuit in the SIM drives the internal (IMB) and external reset lines. The circuit releases the internal reset line as V_{DD} ramps up to the minimum specified value, and SIM pins are initialized. When V_{DD} reaches the specified minimum value, the clock synthesizer VCO begins operation. Clock frequency ramps up to the specified limp mode frequency. The external RESET line remains asserted until the clock synthesizer PLL locks and 512 CLKOUT cycles elapse.

The SIM clock synthesizer provides clock signals to the other MCU modules. After the clock is running and the internal reset signal is asserted for four clock cycles, these modules reset. V_{DD} ramp time and VCO frequency ramp time determine how long these four cycles take. Worst case is approximately 15 milliseconds. During this period, module port pins may be in an indeterminate state. While input-only pins can be put in a known state by means of external pull-up resistors, external logic on input/output or output-only pins must condition the lines during this time. Active drivers require high-impedance buffers or isolation resistors to prevent conflict.

3.7.5 Use of Three State Control Pin

Asserting the three-state control (TSC) input causes the MCU to put all output drivers in an inactive, high-impedance state. The signal must remain asserted for 10 clock cycles in order for drivers to change state. There are certain constraints on use of TSC during power-on reset:

When the internal clock synthesizer is used (MODCLK held high during reset), synthesizer ramp-up time affects how long the 10 cycles take. Worst case is approximately 20 milliseconds from TSC assertion.

When an external clock signal is applied (MODCLK held low during reset), pins go to high-impedance state as soon after TSC assertion as 10 clock pulses have been applied to the EXTAL pin.

When TSC assertion takes effect, internal signals are forced to values that can cause inadvertent mode selection. Once the output drivers change state, the MCU must be powered down and restarted before normal operation can resume.

3.8 Interrupts

Interrupt recognition and servicing involve complex interaction between the central processing unit, the system integration module, and a device or module requesting interrupt service.

The CPU32 provides for eight levels of interrupt priority (0–7), seven automatic interrupt vectors and 200 assignable interrupt vector. All interrupts with priorities less than 7 can be masked by the interrupt priority (IP) field in the status register. The CPU32 handles interrupts as a type of asynchronous exception.

Interrupt recognition is based on the states of interrupt request signals $\overline{\text{IRQ}}$[7:1] and the IP mask value. Each of the signals corresponds to an interrupt priority. $\overline{\text{IRQ1}}$ has the lowest priority, and $\overline{\text{IRQ7}}$ has the highest priority.

The IP field consists of three bits. Binary values %000 to %111 provide eight priority masks. Masks prevent an interrupt request of a priority less than or equal to the mask value (except for $\overline{\text{IRQ7}}$) from being recognized and processed. When IP contains %000, no interrupt is masked. During exception processing, the IP field is set to the priority of the interrupt being serviced.

Interrupt request signals can be asserted by external devices or by microcontroller modules. Request lines are connected internally by means of a wired NOR — simultaneous requests of differing priority can be made. Internal assertion of an interrupt request signal does not affect the logic state of the corresponding MCU pin.

External interrupt requests are routed to the CPU via the external bus interface and SIM interrupt control logic. The CPU treats external interrupt requests as though they come from the SIM.

External $\overline{\text{IRQ}}$[6:1] are active-low level-sensitive inputs. External $\overline{\text{IRQ7}}$ is an active-low transition-sensitive input. $\overline{\text{IRQ7}}$ requires both an edge and a voltage level for validity.

$\overline{\text{IRQ}}$[6:1] are maskable. $\overline{\text{IRQ7}}$ is nonmaskable. The $\overline{\text{IRQ7}}$ input is transition-sensitive in order to prevent redundant servicing and stack overflow. A nonmaskable interrupt is generated each time $\overline{\text{IRQ7}}$ is asserted, and each time the priority mask changes from %111 to a lower number while $\overline{\text{IRQ7}}$ is asserted.

Table 20 Instruction Set Summary (Continued)

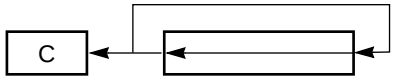
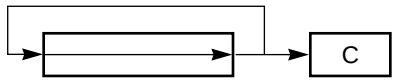
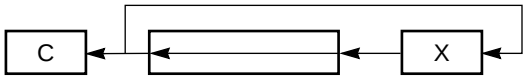
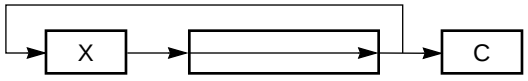
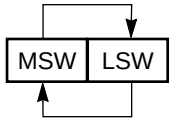
Instruction	Syntax	Operand Size	Operation
MOVEP	Dn, (d16, An) (d16, An), Dn	16, 32	Dn [31 : 24] ⇒ (An + d); Dn [23 : 16] ⇒ (An + d + 2); Dn [15 : 8] ⇒ (An + d + 4); Dn [7 : 0] ⇒ (An + d + 6) (An + d) ⇒ Dn [31 : 24]; (An + d + 2) ⇒ Dn [23 : 16]; (An + d + 4) ⇒ Dn [15 : 8]; (An + d + 6) ⇒ Dn [7 : 0]
MOVEQ	#<data>, Dn	8 ⇒ 32	Immediate data ⇒ Destination
MOVES[1]	Rn, <ea> <ea>, Rn	8, 16, 32	Rn ⇒ Destination using DFC Source using SFC ⇒ Rn
MULS/MULU	<ea>, Dn <ea>, Dl <ea>, Dh : Dl	16 ∗ 16 ⇒ 32 32 ∗ 32 ⇒ 32 32 ∗ 32 ⇒ 64	Source ∗ Destination ⇒ Destination (signed or unsigned)
NBCD	<ea>	8 8	0 – Destination$_{10}$ – X ⇒ Destination
NEG	<ea>	8, 16, 32	0 – Destination ⇒ Destination
NEGX	<ea>	8, 16, 32	0 – Destination – X ⇒ Destination
NOP	none	none	PC + 2 ⇒ PC
NOT	<ea>	8, 16, 32	$\overline{\text{Destination}}$ ⇒ Destination
OR	<ea>, Dn Dn, <ea>	8, 16, 32 8, 16, 32	Source + Destination ⇒ Destination
ORI	#<data>, <ea>	8, 16, 32	Data + Destination ⇒ Destination
ORI to CCR	#<data>, CCR	16	Source + CCR ⇒ SR
ORI to SR[1]	#<data>, SR	16	Source ; SR ⇒ SR
PEA	<ea>	32	SP – 4 ⇒ SP; <ea> ⇒ SP
RESET[1]	none	none	Assert $\overline{\text{RESET}}$ line
ROL	Dn, Dn #<data>, Dn <ea>	8, 16, 32 8, 16, 32 16	
ROR	Dn, Dn #<data>, Dn <ea>	8, 16, 32 8, 16, 32 16	
ROXL	Dn, Dn #<data>, Dn <ea>	8, 16, 32 8, 16, 32 16	
ROXR	Dn, Dn #<data>, Dn <ea>	8, 16, 32 8, 16, 32 16	
RTD	#d	16	(SP) ⇒ PC; SP + 4 + d ⇒ SP
RTE[1]	none	none	(SP) ⇒ SR; SP + 2 ⇒ SP; (SP) ⇒ PC; SP + 4 ⇒ SP; Restore stack according to format
RTR	none	none	(SP) ⇒ CCR; SP + 2 ⇒ SP; (SP) ⇒ PC; SP + 4 ⇒ SP
RTS	none	none	(SP) ⇒ PC; SP + 4 ⇒ SP
SBCD	Dn, Dn – (An), – (An)	8 8	Destination10 – Source10 – X ⇒ Destination
Scc	<ea>	8	If condition true, then destination bits are set to 1; else, destination bits are cleared to 0
STOP[1]	#<data>	16	Data ⇒ SR; STOP

Table 20 Instruction Set Summary (Continued)

Instruction	Syntax	Operand Size	Operation
SUB	<ea>, Dn Dn, <ea>	8, 16, 32	Destination – Source ⇒ Destination
SUBA	<ea>, An	16, 32	Destination – Source ⇒ Destination
SUBI	#<data>, <ea>	8, 16, 32	Destination – Data ⇒ Destination
SUBQ	#<data>, <ea>	8, 16, 32	Destination – Data ⇒ Destination
SUBX	Dn, Dn – (An), – (An)	8, 16, 32 8, 16, 32	Destination – Source – X ⇒ Destination
SWAP	Dn	16	
TAS	<ea>	8	Destination Tested Condition Codes bit 7 of Destination
TBLS/TBLU	<ea>, Dn Dym : Dyn, Dn	8, 16, 32	Dyn – Dym ⇒ Temp (Temp ∗ Dn [7 : 0]) ⇒ Temp (Dym ∗ 256) + Temp ⇒ Dn
TBLSN/TBLUN	<ea>, Dn Dym : Dyn, Dn	8, 16, 32	Dyn – Dym ⇒ Temp (Temp ∗ Dn [7 : 0]) / 256 ⇒ Temp Dym + Temp ⇒ Dn
TRAP	#<data>	none	SSP – 2 ⇒ SSP; format/vector offset ⇒ (SSP); SSP – 4 ⇒ SSP; PC ⇒ (SSP); SR ⇒ (SSP); vector address ⇒ PC
TRAPcc	none #<data>	none 16, 32	If cc true, then TRAP exception
TRAPV	none	none	If V set, then overflow TRAP exception
TST	<ea>	8, 16, 32	Source – 0, to set condition codes
UNLK	An	32	An ⇒ SP; (SP) ⇒ An, SP + 4 ⇒ SP

1. Privileged instruction.

Pin Names	Mnemonics	Mode	Function
Master In Slave Out	MISO	Master Slave	Serial Data Input to QSPI Serial Data Output from QSPI
Master Out Slave In	MOSI	Master Slave	Serial Data Output from QSPI Serial Data Input to QSPI
Serial Clock	SCK	Master Slave	Clock Output from QSPI Clock Input to QSPI
Peripheral Chip Selects	PCS[3:1]	Master	Select Peripherals
Peripheral Chip Select Slave Select	PCS0 $\overline{SS}$	Master Master Slave	Selects Peripheral Causes Mode Fault Initiates Serial Transfer

5.4.2 QSPI Registers

The programmer's model for the QSPI submodule consists of the QSM global and pin control registers, four QSPI control registers, one status register, and the 80-byte QSPI RAM.

The CPU can read and write to registers and RAM. The four control registers must be initialized before the QSPI is enabled to ensure defined operation. SPCR1 should be written last because it contains QSPI enable bit SPE. Asserting this bit starts the QSPI. The QSPI control registers are reset to a defined state and can then be changed by the CPU. Reset values are shown below each register.

Refer to the following memory map of the QSPI.

Address	Name	Usage
$YFFC18	SPCR0	QSPI Control Register 0
$YFFC1A	SPCR1	QSPI Control Register 1
$YFFC1C	SPCR2	QSPI Control Register 2
$YFFC1E	SPCR3	QSPI Control Register 3
$YFFC1F	SPSR	QSPI Status Register
$YFFD00	RAM	QSPI Receive Data (16 Words)
$YFFD20	RAM	QSPI Transmit Data (16 Words)
$YFFD40	RAM	QSPI Command Control (8 Words)

Writing a different value into any control register except SPCR2 while the QSPI is enabled disrupts operation. SPCR2 is buffered to prevent disruption of the current serial transfer. After completion of the current serial transfer, the new SPCR2 values become effective.

Writing the same value into any control register except SPCR2 while the QSPI is enabled has no effect on QSPI operation. Rewriting NEWQP in SPCR2 causes execution to restart at the designated location.

SPCR0 — QSPI Control Register 0 **$YFFC18**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MSTR	WOMQ	BITS				CPOL	CPHA	SPBR							
RESET:															
0	0	0	0	0	0	0	1	0	0	0	0	0	1	0	0

SPCR0 contains parameters for configuring the QSPI before it is enabled. The CPU can read and write this register. The QSM has read-only access.

Table 25 SCI Baud Rates

Nominal Baud Rate	Actual Rate with 16.78-MHz Clock	SCBR Value	Actual Rate with 20.97-MHz Clock	SCBR Value
64*	64.0	$1FFF	—	—
110	110.0	$129E	110.0	$1745
300	299.9	$06D4	300.1	$0888
600	599.9	$036A	600.1	$0444
1200	1199.7	$0165	1200.3	$0222
2400	2405.0	$00DA	2400.6	$0111
4800	4810.0	$006D	4783.6	$0089
9600	9532.5	$0037	9637.6	$0044
19200	19418.1	$0016	19275.3	$0022
38400	37449.1	$000E	38550.6	$0011
76800	74898.3	$0007	72817.8	$0009
Maximum Rate	524288.0	$0001	655360.0	$0001

*A rate of 64 baud is not available with a 20.97-MHz system clock. To achieve this rate, the SYNCR can be programmed to generate a lower system clock rate.

SCCR1 — SCI Control Register 1 **$YFFC0A**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	SCBR												
RESET:															
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

SCCR1 contains SCI configuration parameters. The CPU can read and write this register at any time. The SCI can modify RWU in some circumstances. In general, interrupts enabled by these control bits are cleared by reading SCSR, then reading (receiver status bits) or writing (transmitter status bits) SCDR.

Bit 15 — Not Implemented

LOOPS — Loop Mode

0 = Normal SCI operation, no looping, feedback path disabled
1 = Test SCI operation, looping, feedback path enabled

LOOPS controls a feedback path on the data serial shifter. When loop mode is enabled, SCI transmitter output is fed back into the receive serial shifter. TXD is asserted (idle line). Both transmitter and receiver must be enabled before entering loop mode.

WOMS — Wired-OR Mode for SCI Pins

0 = If configured as an output, TXD is a normal CMOS output.
1 = If configured as an output, TXD is an open-drain output.

WOMS determines whether the TXD pin is an open-drain output or a normal CMOS output. This bit is used only when TXD is an output. If TXD is used as a general-purpose input pin, WOMS has no effect.

ILT — Idle-Line Detect Type

0 = Short idle-line detect (start count on first one)
1 = Long idle-line detect (start count on first one after stop bit(s))

Table 26 GPT Address Map

Access	Address	15 8	7 0
S	$YFF900	GPT MODULE CONFIGURATION (GPTMCR)	
S	$YFF902	(RESERVED FOR TEST)	
S	$YFF904	INTERRUPT CONFIGURATION (ICR)	
U	$YFF906	PGP DATA DIRECTION (DDRGP)	PGP DATA (PORTGP)
U	$YFF908	OC1 ACTION MASK (OC1M)	OC1 ACTION DATA (OC1D)
U	$YFF90A	TIMER COUNTER (TCNT)	
U	$YFF90C	PA CONTROL (PACTL)	PA COUNTER (PACNT)
U	$YFF90E	INPUT CAPTURE 1 (TIC1)	
U	$YFF910	INPUT CAPTURE 2 (TIC2)	
U	$YFF912	INPUT CAPTURE 3 (TIC3)	
U	$YFF914	OUTPUT COMPARE 1 (TOC1)	
U	$YFF916	OUTPUT COMPARE 2 (TOC2)	
U	$YFF918	OUTPUT COMPARE 3 (TOC3)	
U	$YFF91A	OUTPUT COMPARE 4 (TOC4)	
U	$YFF91C	INPUT CAPTURE 4/OUTPUT COMPARE 5 (TI4/O5)	
U	$YFF91E	TIMER CONTROL 1 (TCTL1)	TIMER CONTROL 2 (TCTL2)
U	$YFF920	TIMER MASK 1 (TMSK1)	TIMER MASK 2 (TMSK2)
U	$YFF922	TIMER FLAG 1 (TFLG1)	TIMER FLAG 2 (TFLG2)
U	$YFF924	FORCE COMPARE (CFORC)	PWM CONTROL C (PWMC)
U	$YFF926	PWM CONTROL A (PWMA)	PWM CONTROL B (PWMB)
U	$YFF928	PWM COUNT (PWMCNT)	
U	$YFF92A	PWMA BUFFER (PWMBUFA)	PWMB BUFFER (PWMBUFB)
U	$YFF92C	GPT PRESCALER (PRESCL)	
	$YFF92E–$YFF93F	NOT USED	

Y = M111, where M is the logic state of the modmap (MM) bit in SIMCR.

6.2 Capture/Compare Unit

The capture/compare unit features three input capture channels, four output compare channels, and one input capture/output compare channel (function selected by control register). These channels share a 16-bit free-running counter (TCNT), which derives its clock from seven stages of a 9-stage prescaler or from external clock input PCLK. This section, which is similar to the timer found on the MC68HC11F1, also contains one pulse accumulator channel. The pulse accumulator logic includes its own 8-bit counter and can operate in either event counting mode or gated time accumulation mode. Refer to the following block diagrams of the GPT timer and prescaler.

6.4 GPT Registers

GPTMCR — GPT Module Configuration Register **$YFF900**

15	14	13	12	11	10	9	8	7	6	5	4	3			0
STOP	FRZ1	FRZ0	STOPP	INCP	0	0	0	SUPV	0	0	0	IARB			
RESET:															
0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0

The GPTMCR contains parameters for configuring the GPT.

STOP — Stop Clocks
- 0 = Internal clocks not shut down
- 1 = Internal clocks shut down

FRZ1 — Not implemented at this time

FRZ0 — FREEZE Response
- 0 = Ignore FREEZE
- 1 = FREEZE the current state of the GPT

STOPP — Stop Prescaler
- 0 = Normal operation
- 1 = Stop prescaler and pulse accumulator from incrementing. Ignore changes to input pins.

INCP — Increment Prescaler
- 0 = Has no meaning
- 1 = If STOPP is asserted, increment prescaler once and clock input synchronizers once.

SUPV — Supervisor/Unrestricted Data Space
- 0 = Registers with access controlled by SUPV bit are accessible from either user or supervisor privilege level.
- 1 = Registers with access controlled by SUPV bit are restricted to supervisor access only.

IARB — Interrupt Arbitration Field

The IARB field is used to arbitrate between simultaneous interrupt requests of the same priority. Each module that can generate interrupt requests must be assigned a unique, non-zero IARB field value. Refer to **3.8 Interrupts** for more information.

MTR — GPT Module Test Register (Reserved) **$YFF902**

This address is currently unused and returns zeros if read. It is reserved for GPT factory test.

ICR — GPT Interrupt Configuration Register **$YFF904**

15			12	11	10		8	7			4	3	2	1	0
IPA				0	IPL			IVBA				0	0	0	0
RESET:															
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

IPA — Interrupt Priority Adjust

Specifies which GPT interrupt source is given highest internal priority

IPL — Interrupt Priority Level

Specifies the priority level of interrupts generated by the GPT.

IVBA — Interrupt Vector Base Address

Most significant nibble of interrupt vector number generated by the GPT when an interrupt service request is acknowledged.

7 Summary of Changes

This is a complete revision, with complete reprint. All known errors in the publication have been corrected. The following summary lists significant changes. Typographical errors that do not affect content are not annotated.

Page 2	Revised ordering information.
Page 5	New block diagram drawn.
Page 6	New 132-pin assignment diagram drawn.
Page 7	New 144-pin assignment diagram drawn.
Page 8	New address map drawn.
Page 9-13	Added Signal Description section.
Page 14-46	Expanded and revised SIM section. Made all register diagrams and bit mnemonics consistent. Incorporated new information concerning the system clock, resets, interrupts, and chip-select circuits.
Page 47-55	Expanded and revised CPU section. Made all register diagrams and bit mnemonics consistent. Revised instruction set summary information.
Page 56-76	Expanded and revised QSM section. Made all register diagrams and bit mnemonics consistent. Added information concerning SPI and SCI operation.
Page 77-89	Expanded and revised GPT section. Made all registerdiagrams and bit mnemonics consistent. Added information concerning input capture, output compare, and PWM operation.